PIN Diode Shunt Switch Element

Features

- Supports up to 20 W Power •
- Low Insertion Loss 0.5 dB @ 10 GHz •
- High Isolation 40 dB @ 3 GHz •
- **RoHS*** Compliant •

Description

The MSWSS-040-30 is a surface mount medium power series shunt switch. The shunt device has broad band high isolation. This device can be surface mounted onto a PC board to give a low insertion loss and high Isolation switch. The device can handle up to 20 watts of power. Hot switching will depend on the speed of switch driver.

Electrical Specifications: T. = +25°C

* Restrictions on Hazardous Substances, European Union Directive 2011/65/EU.

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1

Parameter	Test Conditions	Units	Min.	Тур.	Мах
Breakdown Voltage	I _R = 10 mA	V	500	_	_
Reverse Current	V _B = 80 V	nA	_	_	100
Forward Voltage	I _F = 100 mA	V	_	900	_
Junction Capacitance	V _R = 10 V, 1 MHz Shunt Series	pF	_	0.15 0.15	
Series Resistance	I _F = 100 mA, 100 MHz Shunt Series	Ω	_	0.8 0.8	1.0 1.0
Lifetime	I _F = 10 mA, I _R = 6 mA , 50% Shunt Series	ns	_	2200 1500	
I-Region	Shunt Series	μm	_	80 80	
Insertion Loss	I = -50 mA F = <8 GHz F = <3 GHz	dB	_	0.15 0.3	0.3 0.5
Isolation	I = -50 mA F = <8 GHz F = <3 GHz	dB	35 25	45 30	
Return Loss	I = -50 mA F = <8 GHz	dB	23	28	





Rev. V1

PIN Diode Shunt Switch Element

Rev. V1

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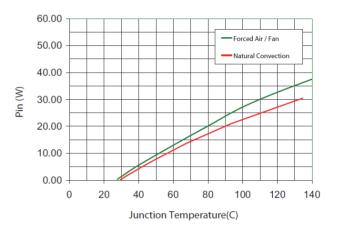
Absolute Maximum Ratings^{3,4}

Parameter	Absolute Maximum		
Breakdown Voltage	500 V		
Forward Current	500 mA		
Thermal Resistance	30 W CW		
Junction Temperature	+150°C		
Storage Temperature	-65°C to +125°C		
Solder Temperature	+260°C per JEDEC STD-J-20C		

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

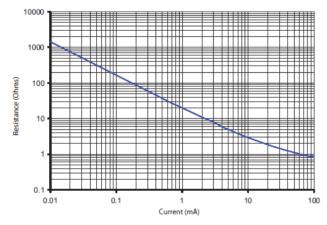
4. MACOM does not recommend sustained operation near these survivability limits.

Input Power vs. Junction Temperature (mounted on heat sink @ 25°C, 1.3 GHz)

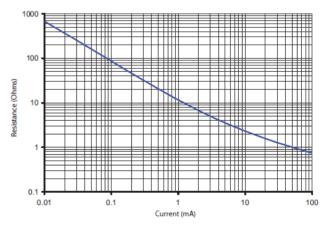


Typical Performance Curves @ +25°C

Resistance vs. Current Series Diode



Resistance vs. Current Shunt Diode



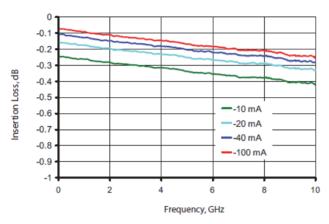
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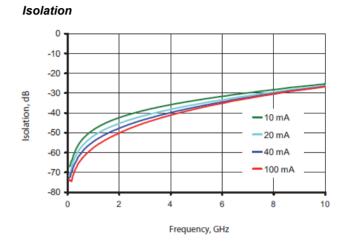
PIN Diode Shunt Switch Element

Rev. V1

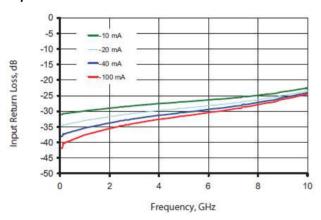
Typical Performance Curves @ +25°C

Insertion Loss

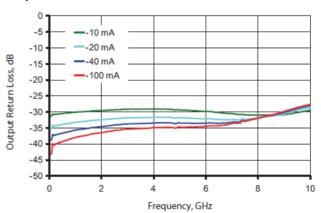




Input Return Loss



Output Return Loss



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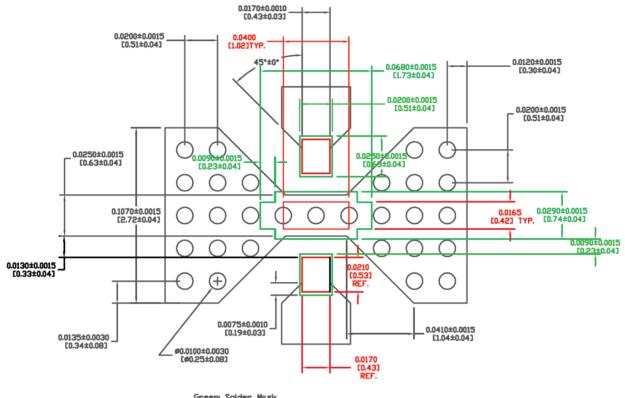
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Rev. V1

Printed Circuit Board Layout



Green: Solder Mask RediStencil

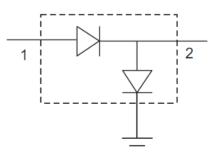
Assembly

If possible, use copper filled vias underneath pin 3 for better thermals; otherwise, use vias that are plated through, filled and plated over.

Solder mask should provide a 60 μ m clearance between copper pad and solder mask underneath package and 125 μ m clearance on outside edges of package. Rounded package pads should have matching rounded solder mask openings.

Use circles or squares for the thermal land stencil such that there is only 50% to 80% solder paste coverage.

Electrical Schematic



4

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PIN Diode Shunt Switch Element

Rev. V1

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0.0310±0.0040 [0.79±0.10] 0.0150±0.0040 0.0470±0.0050 [0.38±0.10] 0.0160 [1.19±0.13] [0.41] TYP. 3 0.0140±0.0040 [0.35±0.10] 0.0770±0.0050 0.0230±0.0050 2.4 [1.96±0.13] [0.51±0.13] 0.0100 [0.26]TYP. 0.0145±0.0040 1 [0.37±0.10] 0.0010 [0.03] TYP. 0.0080 [0.20] TYP. 0.0310±0.0050 [0.79±0.13] PART NUMBER FOR NONSYMMETRICAL DESIGN CATHODE LINE OR INPUT MARK Notes: 0.0080 Pad 1,3: Anode [0.201 TYP. Pad 2,4: Cathode, RF and DC ground Dimensions in inches [mm]. Dimensions do not include mold flashing. 0.0150 Burrs and dumbar shall not exceed 0.002" per surface. [0.38] Lead co-planarity is 0.003" maximum. TYP.

Outline: 2012 (molded plastic DFN)

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5

PIN Diode Shunt Switch Element



Rev. V1

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